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APPLICANT
TAKASHIMA, et al.

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U.S. PATENT DOCUMENTS

[illegible]

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		DOCUMENT NUMBER							DATE	COUNTRY	CLASS	SUBCLAS S	ABSTRACT	
													YES	NO
		0	1	0	9	2	4	5	2/8/01	WO				
		0	9	6	4	0	3	1	12/15/99	Europe				
		0	3	0	1	7	1	9	2/1/89	Europe				
		1	1	8	2	2	2	8	2/27/02	Europe				
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	Patent Abstracts of Japan, Publication No.: 01320159; Publication Date: 12/26/89; Application No.: 6321/88; Application No.: 63153325; Applicant: Mitsubishi Kasei Corp.; Inventor: Takamiya Naoki; LAMINATED AND ORIENTED MOLDING	

EXAMINER

DATE CONSIDERED

7/2003